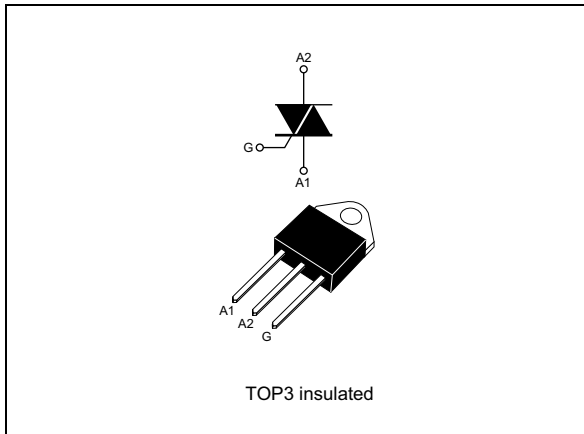


## 40 A high voltage Triacs

Datasheet - production data



### Description

The TPDVxx40 series use a high performance alternistor technology. Featuring very high commutation levels and high surge current capability, this family is well adapted to power control on inductive load (motor, transformer...).

Table 1. Device summary

Parameter	Blocking voltage $V_{DRM}/V_{RRM}$	On-state current $I_{T(RMS)}$	Gate current $I_{GT}$
TPDV640RG	600 V	40 A	200 mA
TPDV840RG	800 V		
TPDV1240RG	1200 V		

### Features

- On-state current ( $I_{T(RMS)}$ ): 40 A
- Max. blocking voltage ( $V_{DRM}/V_{RRM}$ ): 1200 V
- Gate current ( $I_{GT}$ ): 200 mA
- Commutation at 10 V/ $\mu$ s: up to 142 A/ms
- Noise immunity: 500 V/ $\mu$ s
- Insulated package:
  - 2,500 V rms (UL recognized: E81734)

# 1 Characteristics

**Table 2. Absolute ratings (limiting values)**

Symbol	Parameter		Value	Unit	
$I_{T(RMS)}$	On-state rms current (180° conduction angle)		$T_c = 75\text{ °C}$ 40	A	
$I_{TSM}$	Non repetitive surge peak on-state current	$t_p = 2.5\text{ ms}$	$T_j = 25\text{ °C}$	590	A
		$t_p = 8.3\text{ ms}$		370	
		$t_p = 10\text{ ms}$		350	
$I^2t$	$I^2t$ value for fusing	$t_p = 10\text{ ms}$	$T_j = 25\text{ °C}$	610	A <sup>2</sup> S
$di/dt$	Critical rate of rise of on-state current $I_G = 500\text{ mA}; di_G/dt = 1\text{ A}/\mu\text{s}$	Repetitive $F = 50\text{ Hz}$		20	A/ $\mu\text{s}$
		Non repetitive		100	
$V_{DRM}$ $V_{RRM}$	Repetitive peak off-state voltage	TPDV640	$T_j = 125\text{ °C}$	600	V
		TPDV840		800	
		TPDV1240		1200	
$T_{stg}$ $T_j$	Storage junction temperature range		-40 to +150		°C
	Operating junction temperature range		-40 to +125		
$T_L$	Maximum lead temperature for soldering during 10 s at 2 mm from case		260	°C	
$V_{INS(RMS)}^{(1)}$	Insulation rms voltage		2500	V	

1. A1, A2, gate terminals to case for 1 minute

**Table 3. Electrical Characteristics ( $T_j = 25\text{ °C}$ , unless otherwise specified)**

Symbol	Test condition	Quadrant		Value	Unit	
$I_{GT}$	$V_D = 12\text{ V DC}, R_L = 33\ \Omega$	I - II - III	Max.	200	mA	
$V_{GT}$			Max.	1.5	V	
$V_{GD}$	$V_D = V_{DRM}, R_L = 3.3\text{ k}\Omega$	$T_j = 125\text{ °C}$	I - II - III	Min.	0.2	V
$t_{gt}$	$V_D = V_{DRM}, I_G = 500\text{ mA}, di_G/dt = 3\text{ A}/\mu\text{s}$		I - II - III	Typ.	2.5	$\mu\text{s}$
$I_H^{(1)}$	$I_T = 500\text{ mA}$ Gate open			Typ.	50	mA
$I_L$	$I_G = 1.2 \times I_{GT}$	I - III	Typ.	100	mA	
		II		200		
$dV/dt$	Linear slope up to : $V_D = 67\% V_{DRM}$ Gate open	$T_j = 125\text{ °C}$		Min.	500	V/ $\mu\text{s}$
$V_{TM}^{(1)}$	$I_{TM} = 56\text{ A}, t_p = 380\ \mu\text{s}$			Max.	1.8	V
$I_{DRM}$ $I_{RRM}$	$V_{DRM} = V_{RRM}$	$T_j = 25\text{ °C}$		Max.	20	$\mu\text{A}$
		$T_j = 125\text{ °C}$			8	mA
$(di/dt)_c^{(1)}$	$(dV/dt)_c = 200\text{ V}/\mu\text{s}$	$T_j = 125\text{ °C}$		Min.	35	A/ms
	$(dV/dt)_c = 10\text{ V}/\mu\text{s}$				142	

1. For either polarity of electrode A<sub>2</sub> voltage with reference to electrode A<sub>1</sub>.

Table 4. Gate characteristics (maximum values)

Symbol	Parameter	Value	Unit
$P_{G(AV)}$	Average gate power dissipation	1	W
$P_{GM}$	Peak gate power dissipation	$t_p = 20 \mu s$ 40	W
$I_{GM}$	Peak gate current	$t_p = 20 \mu s$ 8	A
$V_{GM}$	Peak positive gate voltage	$t_p = 20 \mu s$ 16	V

Table 5. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient	50	$^{\circ}C/W$
$R_{th(j-c) DC}$	Junction to case for DC	1.2	$^{\circ}C/W$
$R_{th(j-c) AC}$	Junction to case for 360 $^{\circ}$ conduction angle (F = 50 Hz)	0.9	$^{\circ}C/W$

Figure 1. Max. rms power dissipation versus on-state rms current (F = 50 Hz) (curves limited by (dI/dt)c)

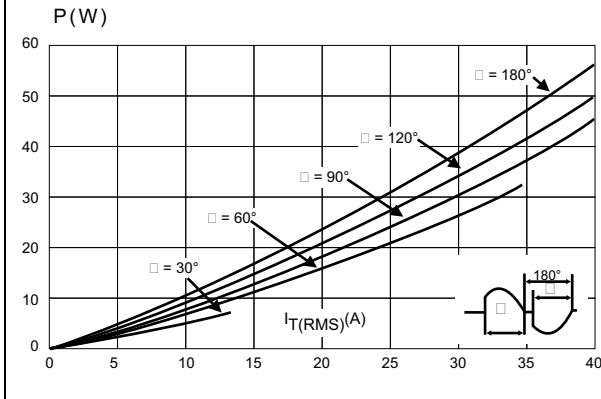


Figure 2. Max. rms power dissipation and max. allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for various  $R_{th}$

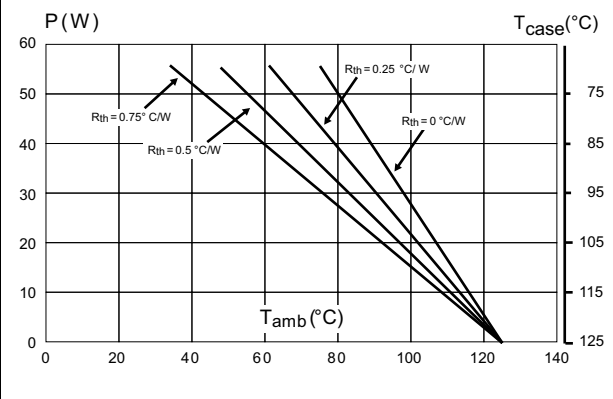


Figure 3. On-state rms current versus case temperature

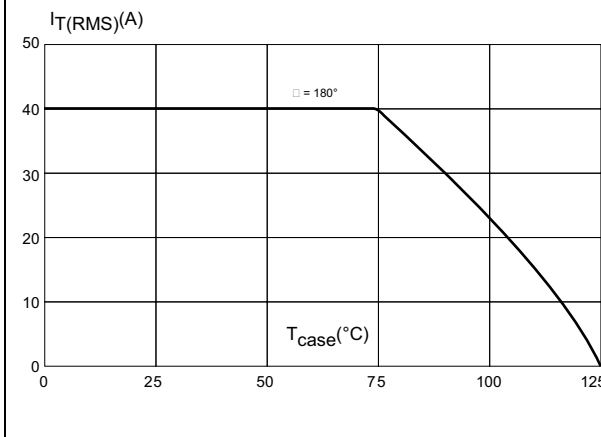
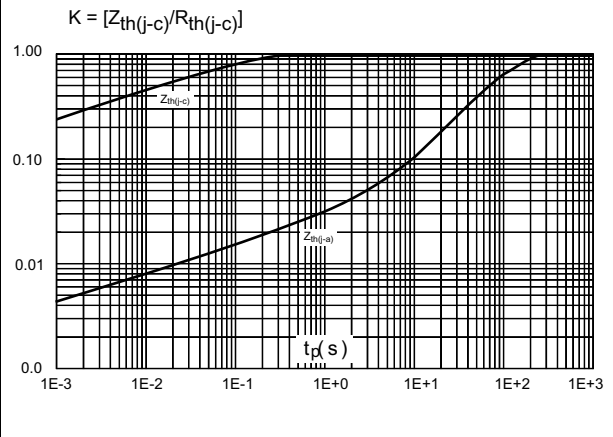
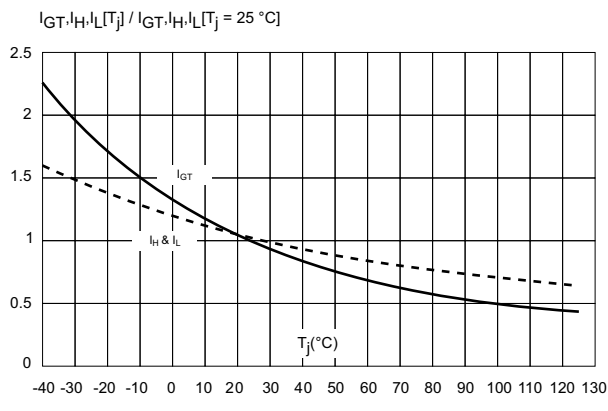


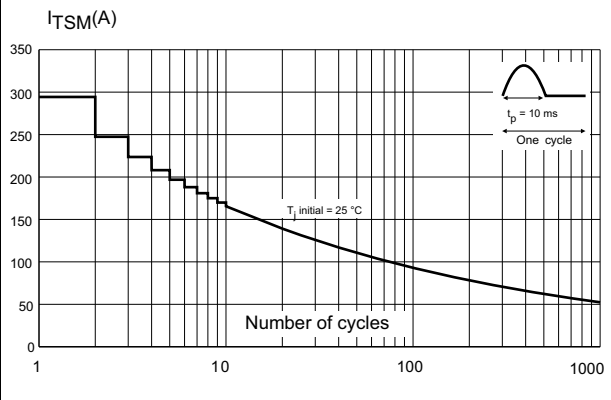
Figure 4. Relative variation of thermal impedance versus pulse duration



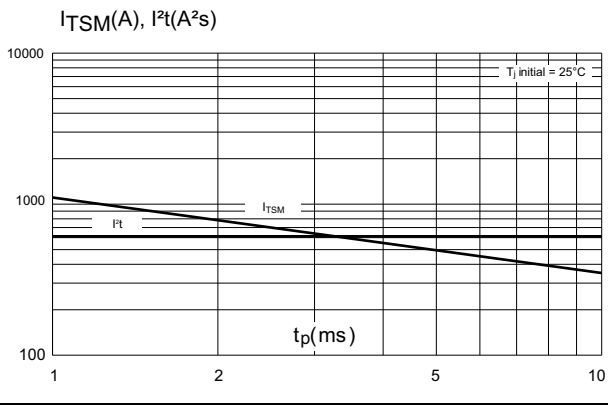
**Figure 5. Relative variation of gate trigger current and holding current versus junction temperature**



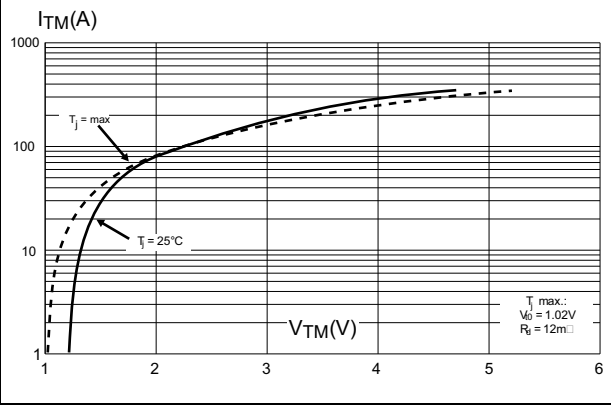
**Figure 6. Non repetitive surge peak on-state current versus number of cycles**



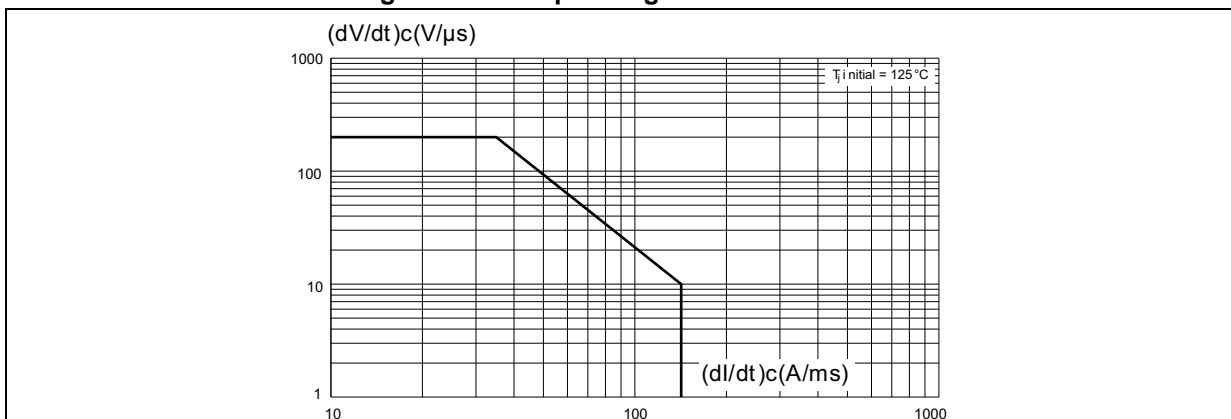
**Figure 7. Non-repetitive surge peak on-state current for a sinusoidal pulse and corresponding values of I²t**



**Figure 8. On-state characteristics (maximum values)**



**Figure 9. Safe operating area below curve**



## 2 Package information

- Epoxy meets UL94, V0
- Cooling method:C (by conduction)
- Recommended torque value:0.9 to 1.2 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK<sup>®</sup> is an ST trademark.

### 2.1 TOP3 insulated package information

Figure 10. TOP3 insulated package outline

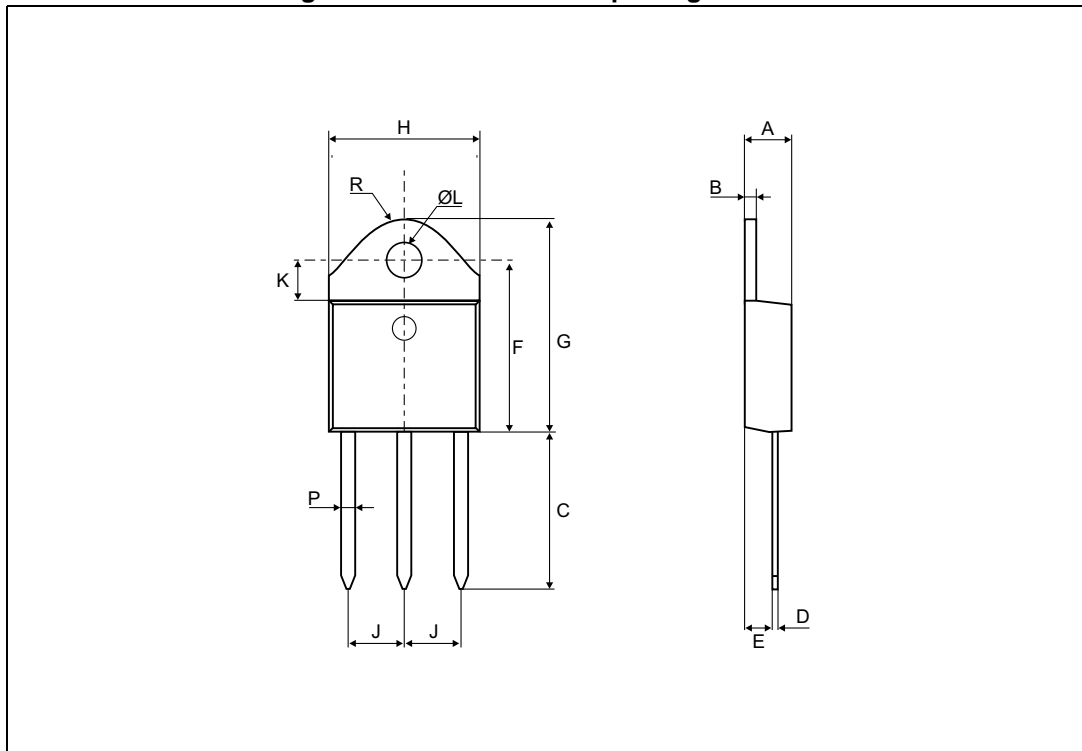


Table 6. TOP3 insulated package mechanical data

Ref.	Dimensions					
	Millimeters			Inches <sup>(1)</sup>		
	Typ.	Min.	Max.	Typ.	Min.	Max.
A		4.4	4.6		0.173	0.181
B		1.45	1.55		0.057	0.061
C		14.35	15.60		0.565	0.614
D		0.5	0.7		0.020	0.028
E		2.7	2.9		0.106	0.114
F		15.8	16.5		0.622	0.650
G		20.4	21.1		0.815	0.831
H		15.1	15.5		0.594	0.610
J		5.4	5.65		0.213	0.222
K		3.4	3.65		0.134	0.144
ØL		4.08	4.17		0.161	0.164
P		1.20	1.40		0.047	0.055
R	4.60			0.181		

1. Values in inches are converted from mm and rounded to 4 decimal digits.

### 3 Ordering information

**Table 7. Ordering information**

Order code	Marking	Package	Weight	Base qty.	delivery mode
TPDV640RG	TPDV640	TOP3 insulated	4.5 g	30	Tube
TPDV840RG	TPDV840				
TPDV1240RG	TPDV1240				

### 4 Revision history

**Table 8. Document revision history**

Date	Revision	Changes
30-Mar-2011	1	Initial release.
10-Jun-2015	2	Updated <a href="#">Table 3</a> . Updated <a href="#">Figure 9</a> . Format updated to current standard.

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